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Docket No.: 4590-426

JC17 Rec'd PCT/PTO <sup>PATENT</sup> 20 JUN 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Philippe KERTESZ et al.

U.S. Patent Application No.: -----

Filed: *herewith*

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Confirmation No.

Group Art Unit: -----

For: MICROWAVE PACKAGE WITH SURFACE MOUNTING AND CORRESPONDING  
MOUNTING WITH A MULTILAYER CIRCUIT

**PRELIMINARY AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Preliminary to examination of the above-referenced application, please amend the  
application as follows: